ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoo nternational and Pan-Ameri	kburn, Illinois	s. All rights reserv	tion with lower	r level p	arts, the	declaratio	n encor	mpasses	all lower	level mate	erials for	which th	e item is an assembly ne manufacturer has eclaration.
1752-2 1.1		Web Site for Informat	71				aration Class * s 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa								
Supplier Information															
Company Name *	Company Unique ID	Unique ID Au	Unique ID Authority			Response Date *			Response Document ID						
Anaren Microwave					2017-	12-14									
Contact Name * Title - Contact				Phone - Con	Email	- Contac	t *		_						
Sarvesh Nair Project Engineer				315-432-8909			sarvesh.nair@anaren.com			Du	uplicate	Contact	-> Autho	orized Re	presentative
Authorized Representative * Title - Representative			Phone - Rep	Email	Email - Representative *			Supplier Comments or URL for Additional Information							
Sarvesh Nair Project Engineer			315-432-890	sarvesh.nair@anaren.com											
Requester Item Number		Mfr Item Number		Mfr Item Name		Effectiv	ve Date	Version	Manufa	rfacturing Site		Weight *	UC	DM	Unit Type
	C16A		C16A50Z4		Termination		016	G	Suzhou,C		China 0.03		g		Each
Alternate Recommenda	Alternate Recommendation				Alternate Iter			Item Co	mments			<u> -</u>		•	
Manufacturing Proces	ss In	formation		1							_				
Terminal Plating / Grid Array	Mater	ial	Terminal B	ase Alloy	J-STD-020 MSL R	ating	Peak Proc	ess Body	Temper	ature Ma	ax Time a	t Peak Tem	perature	Number	of Reflow Cycles
Matte Tin (Sn) - with Nickel (Ni) barrier Other				1		2			260 C		30 seconds		3		
Comments										'					
Compliant to RoHS 2 Dir	ectiv	e 2011/65/EU of the	Europear	n Parliament	and of the Counc	cil of 8	June 201	1 & Con	nmissio	n Deleg	ated Dir	ective 20	15/863/E	U of 31	March 2015.

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent change	Lock Supplier Fields					
RoHS Material Composition Declaration Declaration Declaration Type * Custom												
RoHS Directive 2002/95/EC RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium												
RoHS 2 (Directive 2011/65/EU (DIBP).	& 2015/863/EU) Definition Addend	dum: Quantity limit of 0.1% by n	nass (1000 PPM) in homoger	eous material for: Bis(2-ethyll	nexyl) phthalate (DEHP), Butyl b	oenzyl phthalate (BBP), Dibutyl ph	thalate (DBP), Diisobutyl phthalate					
Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.												
RoHS Declaration *	4 - Item(s) does not contain Rol-	1S restricted substances per t	he definition above except f	or selected exemptions		Supplier Acceptance * Ac	ccepted					
Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	on EL-2006/690/EC											
+ - 7c. Lead in electronic ceramic parts (e.g. piezoelectronic devices).												
Declaration Signa	ture											
	ete all of the required field ired by the Requester) are					wn. This will display the	signature area. Digitally sign					

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exemnt	Weight	Unit of Measure	Tolerance		PPM
	Name		Material	Weight	Measure		Levei	oubstance oategory			Gubstance	OAO	Lxcilipt	Weight		-	+	
+1 -	C16A50Z4	+M -M	Conductor	0.00107	3 g	+C -C	Supplier		+S	-S	Lead Containing Glass	65997-18-4	7c. Lead	0.000128	g			120,00
									+S	-s	Silver (Ag)	7440-22-4		0.000944	g			880,00
		+M -M	Substrate	0.02602	2 g	+C -C	Supplier		+S	-S	Aluminum Oxide (Al2O3	1344-28-1		0.000055	g			960,00
			-						+S	-s	*Proprietary/Unknown	Proprietary		0.001040	g			40,000
		+M -M	Thick Film Resis	0.00058	5 g	+C -C	Supplier		+S	-S	Palladium (Pd)	7440-05-3		0.000020	g			34,597
					•				+S	-s	Silver (Ag)	7440-22-4		0.000056	g			95,816
									+S	-s	Lead Containing Glass	65997-18-4	7c. Lead	0.000422	g			722,61
									+S	-s	Ruthenium(IV) dioxide (12036-10-1		0.000086	g			146,97
		+M -M	Protective Layer	0.00084	3 g	+C -C	Supplier		+S	-S	Lead Containing Glass	65997-18-4		0.000540	g			959,30
					•				+S	-s	Epoxy Resin and polym	(1002)		0.000008	g			14,300
									+S	-s	Chromium(III) oxide (Cr	1308-38-9		0.000008	g			14,700
									+S	-s	*Proprietary/Unknown	Proprietary		0.000006	g			11,700
		+M -M	Protective Polyn	0.00094	8 g	+C -C	Supplier		+S	-S	Cobalt (Co)	7440-48-4		0.000284	g			300,00
					•				+S	-s	Molybdenum (Mo)	7439-98-7		0.000379	g			400,00
									+S	-s	Proprietary Metal Comp	Proprietary		0.000094	g			100,00
									+S	-s	Proprietary Blue Pigme	Proprietary		0.000189	g			200,00
		+M -M	Part Number Ma	0.00000	3 g	+C -C	Supplier		+S	-S	Silica amorphous (SiO2	7631-86-9		0.000000	g			142,90
									+S	-s	Titanium dioxide (TiO2)	13463-67-7		0.000003	g			857,10
		+M -M	Plating	0.00203	g	+C -C	Supplier		+S	-S	Tin (Sn)	7440-31-5		0.000571	g			1,000,0
		+M -M	Nickel(external)	0.00034	7 g	+C -C	В	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.000347	g			1,000,0